	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower		e declaratio	on enco	mpasses all lov	ver level mate	erials for wh	e: if the item is an ass nich the manufacture this declaration.	~ 1
1752-2 1.1	rd	Form Type Distribute		neous Mat	erials and Mfg Inf	ormat							
Supplier Information													
Company Name *		Company Unique ID		Unique ID Au	Ithority	Response Da	ate *		Response Do	cument ID			
SEMTECH CORPORATIO	ON	00-847-9941		DUNS	·	2017-02-27							
Contact Name * Roya Motamedi		Title - Contact Supervisor, QA Prod	uct Suppo	Phone - Con 805-498-211		Email - Contact * rmotamedi@semtech.com			Duplicate Contact -> Authorized Representative				
Authorized Representati Roya Motamedi		Title - Representative Supervisor, QA Prod		-	resentative * 1	Emai⊢- Repro rmotamedi@			Supplier Com	ments or URL	for Additic	onal Information	
Requester Item Number	r	Mfr Item Number		Mfr Item Name	•	Effective Date	Version	Manuf	acturing Site	Weight *	UOM	Unit Type	
	uClamp3311PQTCT			Low Voltage	uClamp® for Autor	n		China	0.941		mg	Each	
Alternate Recommenda	Alternate Recommendation						Alternate	e Item Co	omments				
Manufacturing Proces	ss In	formation											
Terminal Plating / Grid Array	Mater	ial	Terminal B	ase Alloy	J-STD-020 MSL Ra	ting Peak Pi	rocess Body	/ Tempe	rature Max Tim	e at Peak Tem	perature Nu	mber of Reflow Cycle	es
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy				1			260 C	;	30 se	conds 3			
Comments uClamp3311PQTCT is R	EAC	H-compliant produc	t, per EU	Regulation E	C1907/2006 to inc	clude recent a	addition o	f SVHC	candidate lis	t of substan	ces in Jan	uary 2017.	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	town - town

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

		Item/SubItem			Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Woight	Unit of	Toleran	ce PPM
		Name			Material	weight	Measure			Levei	Substance Category			Substance	CAS	Exempt	weight	Measure	-	+
+	-1	Die	+M	-М	Doped silicon	0.1613	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.1613	mg		171,40
+	-1	Lead frame	+M	-м	C7025	0.359	mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		0.3439	mg		365,47
						•						+S	-s	Si	7440-21-3		0.0026	mg		2,763
								+C	-C	в	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.0115	mg		12,195
								+C	-C	Supplier		+S	-S	Mg	7439-95-4		0.0006	mg		667
			+M	-м	Ni/Pd/Au plating	0.009	mg	+C	-C	в		+S	-s	Nickel	7440-02-0		0.0083	mg		8,811
								+C	-C	Supplier	middle plating	+S	-s	Pd	7440-05-3		0.0008	mg		801
								+C	-C	Supplier	outer plating	+S	-s	Au	7440-57-5		0.0001	mg		159
+	-1	Bonding wire	+M	-м	Au	0.0075	mg	+C	-C	Supplier		+S	-s	Au	7440-57-5		0.0075	mg		7,986
+	-1	Molding compound	+M	-м	EME-G770HCD	0.366	mg	+C	-C	Supplier		+S	-s	Silica fused	60676-86-0		0.342	mg		363,50
			,			1	1					+S	-s	Epoxy resin	Proprietary		0.011	mg		11,663
												+S	-s	Phenol resin	Proprietary		0.011	mg		11,663
												+S	-s	С	1333-86-4		0.0018	mg		1,944
+	-1	Die attached epoxy	+M	-м	QMI519	0.039	mg	+C	-C	Supplier		+S	-s	Ag	7440-22-4		0.0308	mg		32,770
			,									+S	-s	palladium compound	Proprietary		0.0001	mg		61
												+S	-s	2,6-Di-tert-butyl-p-creso	128-37-0		0.000002	mg		2
												+S	-s	Hydroquinone	123-31-9		0.00000	mg		0.03
												+S	-s	Acrylate	Proprietary		0.0061	mg		6,491
												+S	-s	Bismaleimide resin	Proprietary		0.0012	mg		1,229
												+S	-s	Polymer of polybutadie	Proprietary		0.0004	mg		410